# P-Channel 30-V (D-S) MOSFET

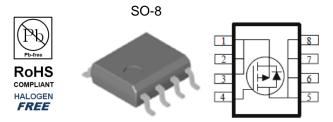
## **Key Features:**

- Low r<sub>DS(on)</sub> trench technology
- · Low thermal impedance
- · Fast switching speed

## **Typical Applications:**

- Load Switches
- DC/DC Conversion
- Motor Drives

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$r_{DS(on)}(m\Omega)$	I□ (A)		
-30	42 @ V <sub>GS</sub> = -10V	-7.1		
	$78 @ V_{GS} = -4.5V$	-5.2		



ABSOLUTE MAXIMUM RATINGS ( $T_A = 25$	°C UNLESS OTH	ERWISE NO	TED)		
Parameter		Symbol	Limit	Units	
Orain-Source Voltage		$V_{DS}$	-30	V	
Gate-Source Voltage		$V_{GS}$	±20	V	
Continuous Proin Comment <sup>a</sup>	T <sub>A</sub> =25°C	;	-7.1		
Continuous Drain Current <sup>a</sup>	T <sub>A</sub> =70°C	- I <sub>D</sub>	-6	Α	
Pulsed Drain Current <sup>b</sup>	n Current <sup>b</sup>		-25		
Continuous Source Current (Diode Conduction) a		Is	-3.6	Α	
Device Discipation 8	T <sub>A</sub> =25°C	P <sub>D</sub>	3.1	W	
Power Dissipation <sup>a</sup>	T <sub>A</sub> =70°C	FD	2.2	V V	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to 150	°C	

THERMAL RESIS	TANCE RATINGS			
Parameter		Symbol	Maximum	Units
Maximum Junction-to-Ambient <sup>a</sup>	t <= 10 sec	$R_{\theta JA}$	40	°C/W
Maximum Junction-to-Ambient	Steady State		80	

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#### Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature

### **Electrical Characteristics**

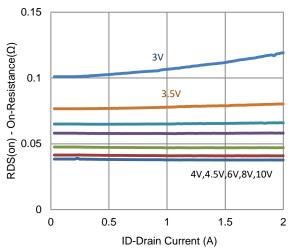
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
	Static					
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = -250 \text{ uA}$	-1			V
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±100	nA
Zoro Cata Valtaga Drain Current		$V_{DS} = -24 \text{ V}, V_{GS} = 0 \text{ V}$			-1	uA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = -24 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$			-10	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = -5 \text{ V}, V_{GS} = -10 \text{ V}$	-11			Α
Drain Cauras On Basistanas a	r	$V_{GS} = -10 \text{ V}, I_{D} = -6 \text{ A}$			42	mΩ
Drain-Source On-Resistance <sup>a</sup>	r <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -4.8 \text{ A}$			78	11122
Forward Transconductance a	g <sub>fs</sub>	$V_{DS} = -15 \text{ V}, I_{D} = -6 \text{ A}$		8		S
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = -1.8 \text{ A}, V_{GS} = 0 \text{ V}$		-0.82		V
		Dynamic <sup>b</sup>				
Total Gate Charge	$Q_g$	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V},$ $I_{D} = -6 \text{ A}$		9		nC
Gate-Source Charge	$Q_{gs}$			3.8		
Gate-Drain Charge	$Q_gd$	1D = 0 A		2.8		
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DS} = -15 \text{ V}, R_1 = 2.5 \Omega,$		6		
Rise Time	t <sub>r</sub>	$V_{DS} = -15 \text{ V}, K_L - 2.5 \Omega,$ $I_D = -6 \text{ A},$		7		ns
Turn-Off Delay Time	$t_{d(off)}$	$V_{GEN} = -10 \text{ V}, R_{GEN} = 6 \Omega$		44		
Fall Time	t <sub>f</sub>	VGEN = 10 V, NGEN = 0 12		19		
Input Capacitance	C <sub>iss</sub>			787		
Output Capacitance	C <sub>oss</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ Mhz}$		90		pF
Reverse Transfer Capacitance	$C_{rss}$			73		

#### **Notes**

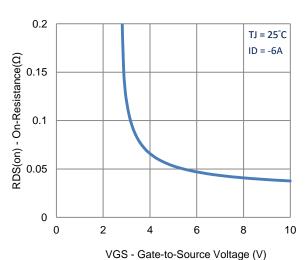
- a. Pulse test: PW <= 300us duty cycle <= 2%.
- b. Guaranteed by design, not subject to production testing.

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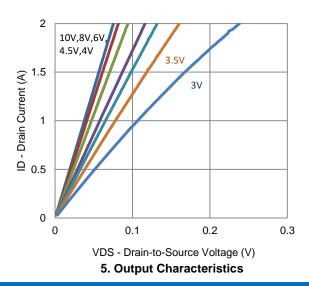
## **Typical Electrical Characteristics**

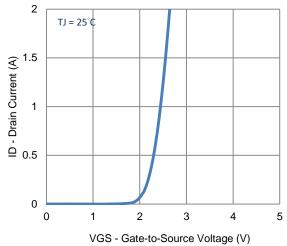


#### 1. On-Resistance vs. Drain Current

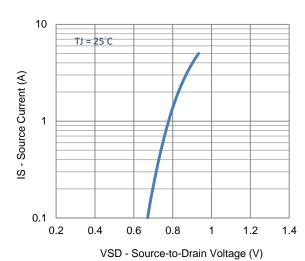


3. On-Resistance vs. Gate-to-Source Voltage

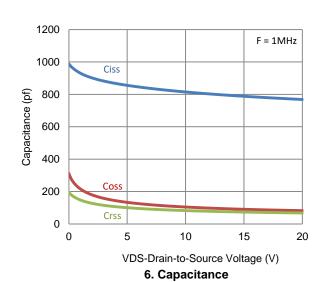




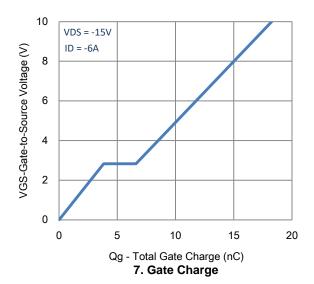
2. Transfer Characteristics

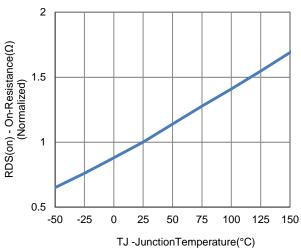


4. Drain-to-Source Forward Voltage



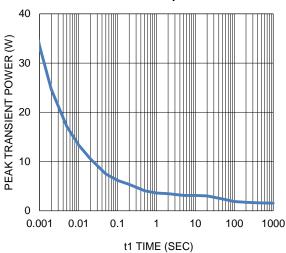
## **Typical Electrical Characteristics**





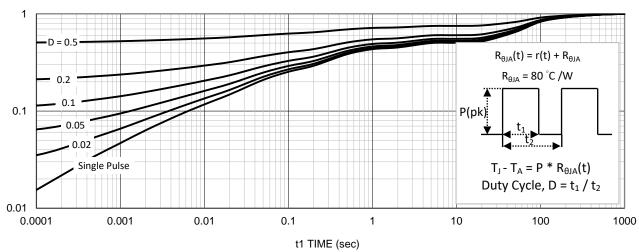
100 10 ID Current (A) SEC 10 SEC 100 SEC 0.1 0.01 0.1 10 100 1000 VDS Drain to Source Voltage (V)





9. Safe Operating Area

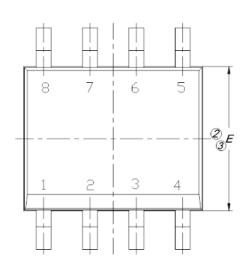
10. Single Pulse Maximum Power Dissipation

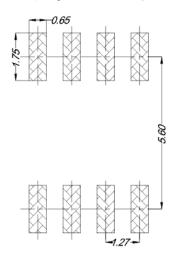


11. Normalized Thermal Transient Junction to Ambient

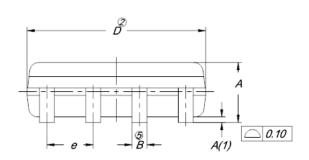
### **Package Information**

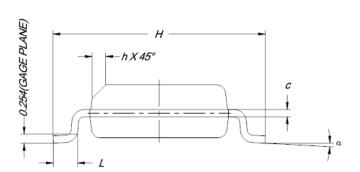
Land Pattern (Only for Reference)





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#### Note:

- 1. All Dimension Are In mm.
- 2. Package Body Sizes Exclude Mold Flash, Protrusion Or Gate Burrs. Mold Flash, Protrusion Or Gate Burrs Shall Not Exceed 0.10 mm Per Side.
- 3. Package Body Sizes Determined At The Outermost Extremes Of The Plastic Body Exclusive Of Mold Flash, Tie Bar Burrs, Gate Burrs And Interlead Flash, But Including Any Mismatch Between The Top And Bottom Of The Plastic Body.
- 4. The Package Top May Be Smaller Than The Package Bottom.
- Dimension "B" Does Not Include Dambar Protrusion. Allowable Dambar Protrusion Shall Be 0.08 mm Total In Excess Of "B" Dimension At Maximum Material Condition. The Dambar Cannot Be Located On The Lower Radius Of The Foot.